

Search Notes

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|---|------------------|---------|------------------|
| L1 | 112 | psg and usg and trench and sti | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/13 10:14 |
| L2 | 78 | psg and usg and trench and sti and sidewall | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/13 10:14 |
| L3 | 66 | psg same usg and trench and sti and sidewall | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/13 10:14 |
| S1 | 1462 | (438/424).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/06/13 10:13 |
| S2 | 324 | (438/430).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/06/06 20:05 |
| S3 | 1 | S2 and rie and polysilicon and ((thermal adj oxide) or (lpteos)) and hdp with cvd | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:22 |
| S4 | 18 | S2 and rie and polysilicon and ((thermal adj oxide) or (lpteos)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:13 |
| S5 | 1218 | trench and rie and polysilicon and ((thermal adj oxide) or (lpteos)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:13 |
| S6 | 81 | trench and rie and polysilicon and ((thermal adj oxide) or (lpteos)) and hdp with cvd | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:13 |

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| S7 | 1 | trench and rie and polysilicon and (lpteos) and hdp with cvd | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:14 |
| S8 | 1 | trench and rie and polysilicon and (lp-teos) and hdp with cvd | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:14 |
| S9 | 1 | trench and rie and polysilicon and (lpteos) and hdp with cvd | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:23 |
| S10 | 80 | trench and rie and polysilicon and (thermal adj oxide) and hdp with cvd | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:23 |
| S11 | 80 | trench and rie and polysilicon and (thermal adj oxide) and hdp with cvd and nitride | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:23 |
| S12 | 123 | trench and rie and polysilicon and (teos) and hdp with cvd and nitride | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:23 |
| S13 | 33 | trench and rie and polysilicon and (ozone with teos) and hdp with cvd and nitride | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:54 |
| S14 | 66 | trench and rie and polysilicon and (ozone with teos) and lpcvd and nitride | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:24 |
| S15 | 14 | trench and rie and polysilicon and lpteos | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/06/06 20:54 |